

C18150/C18400

Application Range													
Cu-Cr alloy with a combination of very high electrical conductivity and very good resistance against relaxation even at 200°C. The alloy is well suited for components needing middle-level strength. Applications are in the field of cell phones, high voltage connectors and photovoltaics.													
Physical Properties											Chemical Position (reference value) %		
Density * g/cm³											Cu (incl. Ag) Rest		
Thermal conductivity * W/(m·K)											Cr 0.20-1.20		
Electr. conductivity *** MS/m											Zr 0.05-0.25		
Electr. conductivity *** IACS (%)											Fe max. 0.30		
Thermal expansion c. ** 10⁻⁶ K											Si max. 0.10		
Modulus of elasticity * Gpa											Other max. 0.10		
Condition	Temper class	Tensile strength	Yield strength	Elongation	Hardness	Electr. Conductivity	Bendability R/t ^{1) 2)} 90°		Bendability R/t ^{1) 2)} 180°		Larson-Miller-Diagram		
		T.S. min. - max. MPa	R _p 0.2 min. MPa	A50 min. %	(reference value) HV	MS/m	GW Strip thickness ≤ 0.5mm	BW Strip thickness ≤ 0.5mm	GW Strip thickness ≤ 0.5mm	BW Strip thickness ≤ 0.5mm			
Cold rolled	R480	480 - 560	450	8	150 - 190	50	1.5	1.5	2	2	 C18400 Only valid up to C70250		
Cold rolled	R540	540 - 630	500	4	160 - 200	50	2	2	2.5	3			
Cold rolled	R540S	540 - 620	500	8	160 - 190	50	1.5	1.5	2	2.5			

*Reference values at room temperature

**Between 20 and 300 °C

*** Values for the lowest temper class

1) r = x · t (strips up to t = 0.50 mm)

2) Sample width = 10 mm / bending at smaller bending widths on request (Evaluation according to page 5.4.2. of Hand-Out)

3) Valid only as thermal stress relieved qualities

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